

Description

The HN2288 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D = 30A

 $R_{DS(ON)} < 12m\Omega @ V_{GS}=10V$

Application

Lithium battery protection

Wireless impact

Mobile phone fast charging

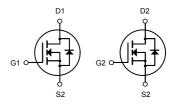
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Package Marking and Ordering Information						
Product ID	Pack	Marking	Qty(PCS)			
HN2288	DFN3X3-8L	HN2288 XXYYS	5000			

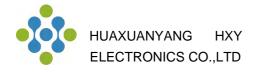
Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage 30		V
VGS	Gate-Source Voltage	±20	V
I₀@Tc=25℃	Continuous Drain Current, V _{GS} @ 10V ¹	30	А
I ⊳@Tc=100 ℃	Continuous Drain Current, V _{GS} @ 10V ¹	23	А
IDM	Pulsed Drain Current ²	66	А
EAS	Single Pulse Avalanche Energy ³	27.2	mJ
IAS	Avalanche Current	26	А
P₀@T _A =25°C	Total Power Dissipation ⁴	2	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-Ambient ¹	85	°C /W
R₀JC	Thermal Resistance Junction-Case ¹	25	°C /W





Dual N-Channel MOSFET



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =250uA	30			V
∆BV _{DSS} ∕∆T _J	BVDSS Temperature Coefficient	Reference to 25° C , I _D =1mA		0.023		V/°C
Rds(on)	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =8A		10	12	
		V _{GS} =4.5V , I _D =6A		15	18	-mΩ
$V_{GS(th)}$	Gate Threshold Voltage		1.2		2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	──V _{GS} =V _{DS} , I _D =250uA		-5.08		mV/°C
1	Drain Source Leekage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	
IDSS	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C		5	5	– uA
lgss	Gate-Source Leakage Current	V_{GS} = ±20V , V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =8A		24		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.8		Ω
Qg	Total Gate Charge (4.5V)			9.63		
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =8A		3.88		nC
\mathbf{Q}_{gd}	Gate-Drain Charge			3.44		
T _{d(on)}	Turn-On Delay Time			4.2		
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =1.5 Ω I_{D} =8A		8.2		20
T _{d(off)}	Turn-Off Delay Time			31		ns
T _f	Fall Time			4		
Ciss	Input Capacitance			940		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		131		pF
Crss	Reverse Transfer Capacitance			109		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current ^{1,5}	$V_G=V_D=0V$, Force Current			9	А
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V
trr	Reverse Recovery Time	IF=8A , di/dt=100A/μs ,		8		nS
Qrr	Reverse Recovery Charge	TJ=25°C		2.9		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle $\leq 2\%$

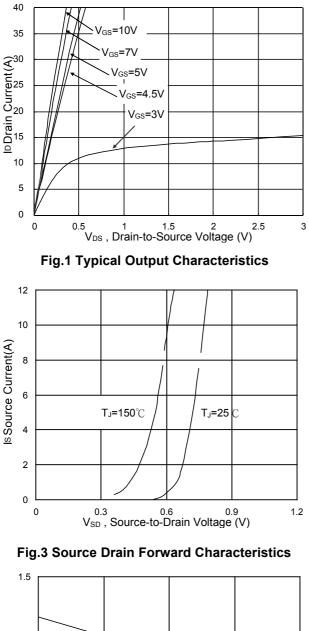
3. The EAS data shows Max. rating . The test condition is $V_{DD}=25V$, $V_{GS}=10V$, L=0.1 mH, $I_{AS}=22A$

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



Typical Characteristics



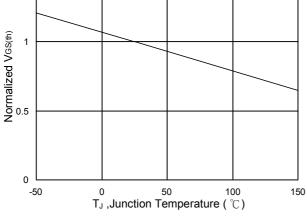


Fig.5 Normalized $V_{\text{GS}(\text{th})}\,\text{vs.}\,\text{T}_{\text{J}}$

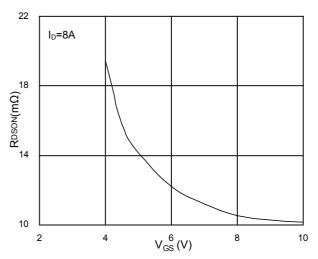


Fig.2 On-Resistance vs. G-S Voltage

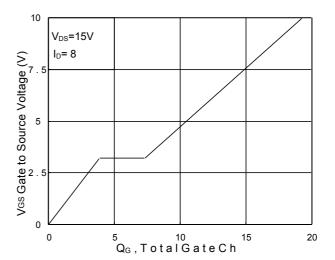


Fig.4 Gate-Charge Characteristics

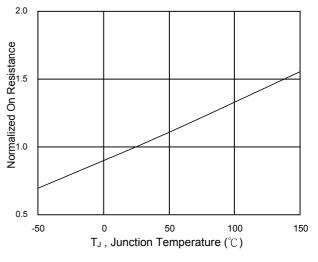
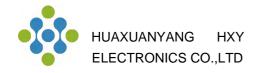


Fig.6 Normalized RDSON vs. TJ



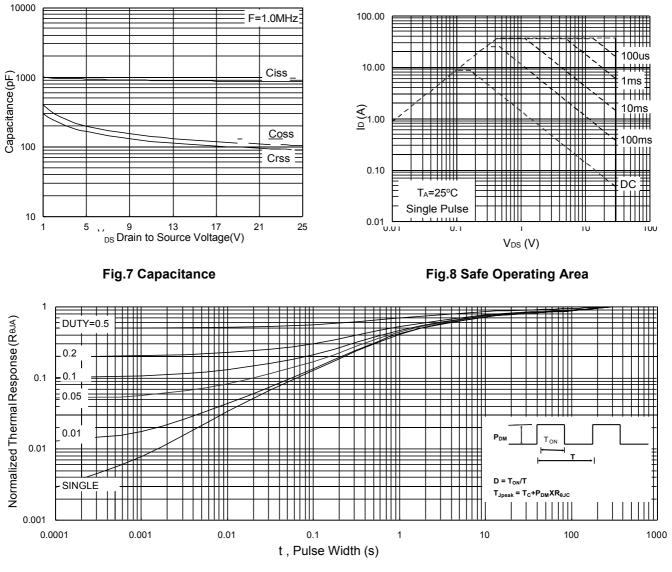
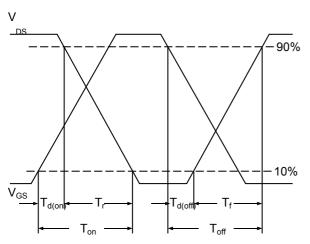
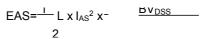


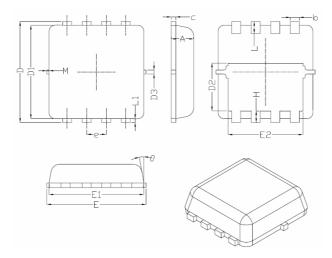
Fig.9 Normalized Maximum Transient Thermal Impedance







DFN3X3-8L Package Information



Sumbol	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
М	*	*	0.15	
θ		10 [°]	12 [°]	



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